

Rev. V1

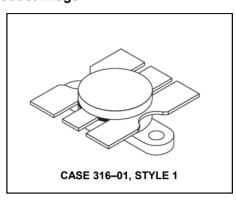
Designed primarily for wideband large—signal output amplifier stages in the 100 to 500 MHz frequency range.

- Guaranteed performance @ 400 MHz, 28 Vdc
   Output power = 80 W over 225 to 400 MHz Band
   Minimum gain = 7.3 dB @ 400 MHz
- Built-in matching network for broadband operation using double match technique
- 100% tested for load mismatch at all phase angles with 30:1 VSWR
- Gold metallization system for high reliability applications
- Characterized for 100 =8 500 MHz

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V <sub>CEO</sub>	33	Vdc
Collector-Base Voltage	V <sub>CBO</sub>	60	Vdc
Emitter–Base Voltage	V <sub>EBO</sub>	4.0	Vdc
Collector Current — Continuous — Peak	I <sub>C</sub>	9.0 12	Adc
Total Device Dissipation @ T <sub>C</sub> = 25°C (1) Derate above 25°C	P <sub>D</sub>	250 1.43	Watts W/°C
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C

### **Product Image**



#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	R <sub>eJC</sub>	0.7	°C/W

### ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted.)

, 0	,				
Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•		•	•	•
Collector–Emitter Breakdown Voltage (I <sub>C</sub> = 80 mAdc, I <sub>B</sub> = 0)	V <sub>(BR)CEO</sub>	33	_	_	Vdc
Collector–Emitter Breakdown Voltage (I <sub>C</sub> = 80 mAdc, V <sub>BE</sub> = 0)	V <sub>(BR)CES</sub>	60	_	_	Vdc
Emitter–Base Breakdown Voltage (I <sub>E</sub> = 8.0 mAdc, I <sub>C</sub> = 0)	V <sub>(BR)EBO</sub>	4.0	_	_	Vdc
Collector–Base Breakdown Voltage (I <sub>C</sub> = 80 mAdc, I <sub>C</sub> = 0)	V <sub>(BR)CBO</sub>	60	_	_	Vdc
Collector Cutoff Current (V <sub>CB</sub> = 30 Vdc, I <sub>E</sub> = 0)	Ісво	_	_	5.0	mAdc
ON CHARACTERISTICS			•		
DC Current Gain (I <sub>C</sub> = 4.0 Adc, V <sub>CE</sub> = 5.0 Vdc)	h <sub>FE</sub>	20	_	80	_

NOTE: (continued)

1

<sup>1.</sup> This device is designed for RF operation. The total device dissipation rating applies only when the device is operated as an RF amplifier.



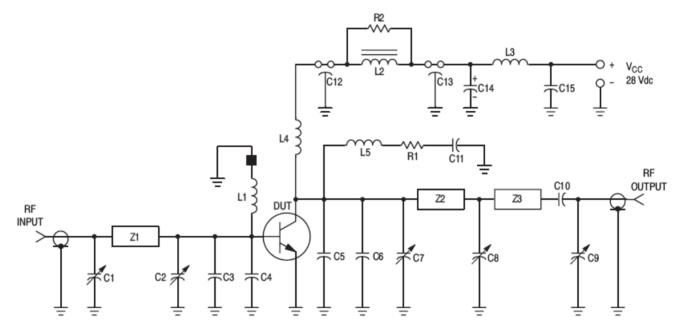
Rev. V1

### DYNAMIC CHARACTERISTICS

Output Capacitance	Cob	_	95	125	pF	Ī
(V <sub>CB</sub> = 28 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz)						l

### ELECTRICAL CHARACTERISTICS - continued (T<sub>C</sub> = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Тур	Max	Unit
FUNCTIONAL TESTS (Figure 1)					
Common–Emitter Amplifier Power Gain (V <sub>CC</sub> = 28 Vdc, P <sub>out</sub> = 80 W, f = 400 MHz)	G <sub>PE</sub>	7.3	9.0	_	dB
Collector Efficiency (V <sub>CC</sub> = 28 Vdc, P <sub>out</sub> = 80 W, f = 400 MHz)	η	50	60	_	%
Load Mismatch (V <sub>CC</sub> = 28 Vdc, P <sub>out</sub> = 80 W, f = 400 MHz, VSWR = 30:1 All Phase Angles)	Ψ	No Degradation in Output Power			



C1, C2, C7, C8, C9 — 1.0-20 pF Piston Trimmer (Johanson JMC 5501)

C3, C4 — 36 pF ATC 100 mil Chip Capacitor

C5, C6 - 43 pF ATC 100 mil Chip Capacitor

C10 — 100 pF UNELCO

C11, C15 — 0.1 µF Erie Redcap

C12, C13 - 680 pF Feedthru

C14 — 1.0 µF 50 V Tantalum

L1 — 4 Turns #22 AWG Enameled, 3/16" ID Closewound with Ferroxcube Bead (#56–590–65/4B) on Ground End of Coil

L2 — Ferroxcube VK200-19/4B Ferrite Choke

L3 — 7 Turns #18 AWG, 11/16" Long, Wound on a 100 kΩ 2.0 Watt Resistor

L4 — 6 Turns #20 AWG Enameled, 3/16" ID Closewound

L5 - 4 Turns #22 AWG Enameled, 1/8" ID Closewound

Z1 - Microstrip 0.2" W x 1.5" L

Z2 - Microstrip 0.17" W x 1.16" L

Z3 - Microstrip 0.17" W x 0.63" L

R1, R2 — 10 Ω 2.0 Watt

Board — Glass Teflon  $\epsilon_\Gamma$  = 2.56, t = 0.062"

Input/Output Connectors Type N

DUT Socket Lead Frame Etched from 80-mil-Thick Copper

Figure 1. 400 MHz Test Circuit



Rev. V1

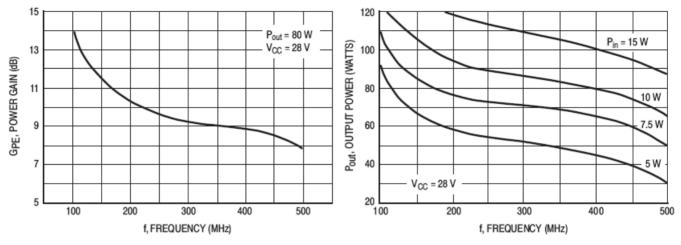


Figure 2. Power Gain versus Frequency

Figure 3. Output Power versus Frequency

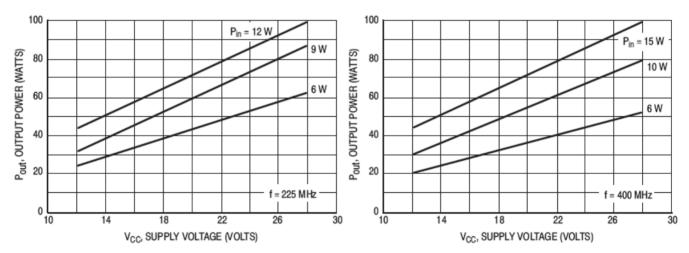


Figure 4. Output Power versus Supply Voltage

Figure 5. Output Power versus Supply Voltage



Rev. V1

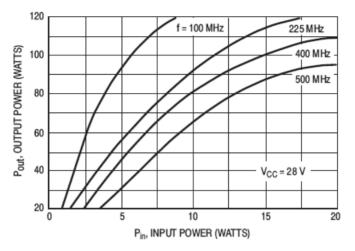
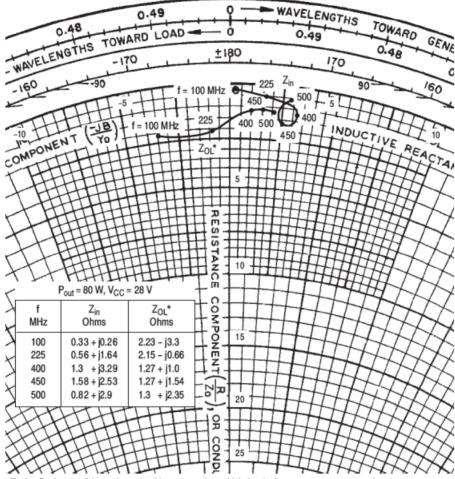


Figure 6. Output Power versus Input Power



Rev. V1



Z<sub>OL</sub>\*= Conjugate of the optimum load impedance into which the device output operates at a given output power, voltage and frequency.

Figure 7. Series Equivalent Input-Output Impedance



Rev. V1

#### PACKAGE DIMENSIONS

